



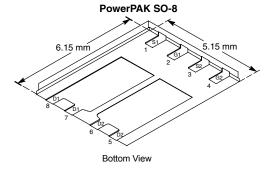
Dual N-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A)		
60	0.021 at V _{GS} = 10 V	9.7		
	0.025 at V _{GS} = 4.5 V	8.9		

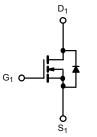
FEATURES

- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET[®] Power MOSFET
- New Low Thermal Resistance PowerPAK[®] Package
- Dual MOSFET for Space Savings

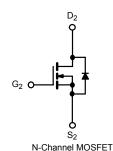




Ordering Information: Si7960DP-T1-E3 (Lead (Pb)-free)
Si7960DP-T1-GE3 (Lead (Pb)-free and Halogen-free)







ABSOLUTE MAXIMUM RATINGS	T _A = 25 °C, unle	ss otherwise n	oted		
Parameter		Symbol	10 s	Steady State	Unit
Drain-Source Voltage		V_{DS}	60		V
Gate-Source Voltage		V_{GS}	± 20		V
Continuous Drain Current (T ₁ = 150 °C) ^a	T _A = 25 °C	1_	9.7	6.2	
Continuous Diain Current (1 j = 150 °C)	T _A = 70 °C	ID	7.8	5.0	
Pulsed Drain Current		I _{DM}	40		Α
Continuous Source Current (Diode Conduction) ^a		I _S	2.9	1.2	
Single Avalanche Current	L = 0.1 mH	I _{AS}	23		
Single Avalanche Energy		E _{AS}	27		mJ
Mariana Damar Dissinational	T _A = 25 °C	- P _D	3.5	1.4	W
Maximum Power Dissipation ^a	T _A = 70 °C		2.2	0.9	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150 260		°C
Soldering Recommendations (Peak Temperature) ^{b, c}		_			C

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Marrian II in ation to Ambrida	t ≤ 10 s	R _{thJA}	26	35	°C/W	
Maximum Junction-to-Ambient ^a	Steady State		60	85		
Maximum Junction-to-Case (Drain)	Steady State	R_{thJC}	2.2	2.7		

Notes:

- a. Surface Mounted on 1" x 1" FR4 board.
- b. See Solder Profile (www.vishay.com/ppg?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

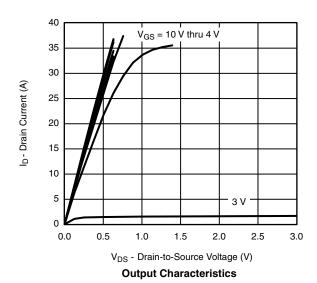
Vishay Siliconix

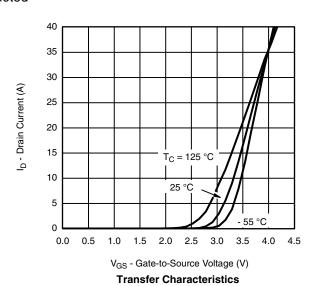


Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static	L					
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1		3	V
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V			1	
		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			5	μΑ
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30			Α
Drain-Source On-State Resistance ^a	В	$V_{GS} = 10 \text{ V}, I_D = 9.7 \text{ A}$		0.017	0.021	
	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 8.9 \text{ A}$		0.020	0.025	Ω
Forward Transconductance ^a	g _{fs}	V _{DS} = 15 V, I _D = 9.7 A		33		S
Diode Forward Voltage ^a	V_{SD}	$I_S = 2.9 \text{ A}, V_{GS} = 0 \text{ V}$		0.8	1.2	٧
Dynamic ^b	<u>'</u>			•		
Total Gate Charge	Q_g			49	75	
Gate-Source Charge	Q _{gs}	$V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 9.7 \text{ A}$		5.7		nC
Gate-Drain Charge	Q _{gd}			8.6		
Gate Resistance	R_g	f = 1 MHz		2		Ω
Turn-On Delay Time	t _{d(on)}			12	20	
Rise Time	t _r	V_{DD} = 30 V, R_L = 30 Ω		12	20	ns
Turn-Off Delay Time	t _{d(off)}	$I_D\cong$ 1 A, V_{GEN} = 10 V, R_G = 6 Ω		60	90	
Fall Time	t _f			17	30	
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 2.9 A, dI/dt = 100 A/μs		30	60	

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





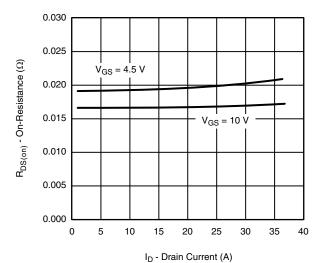
Notes a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.



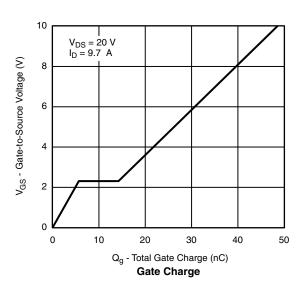




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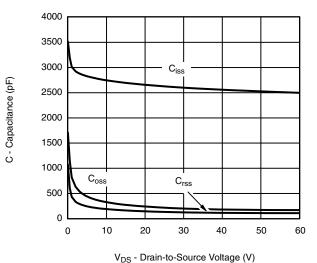


On-Resistance vs. Drain Current

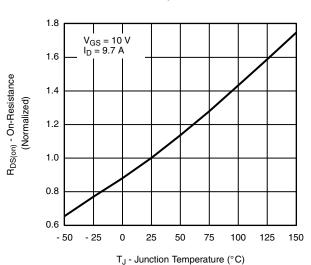


T_J = 150 °C I_S - Source Current (A) 10 T_J = 25 °C 0.0 0.2 0.4 1.0 1.2

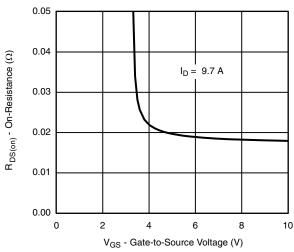
V_{SD} - Source-to-Drain Voltage (V) Source-Drain Diode Forward Voltage







On-Resistance vs. Junction Temperature



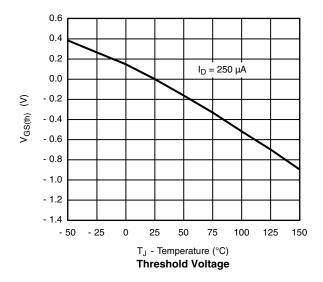
On-Resistance vs. Gate-to-Source Voltage

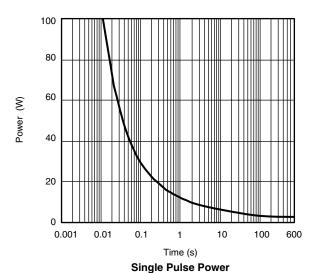
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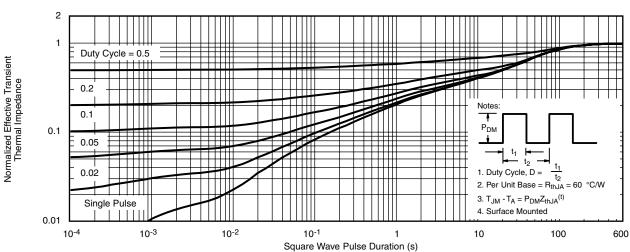
VISHAY.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





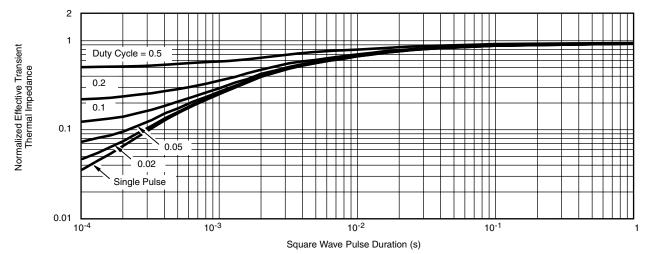
100 Limited by R_{DS(on)} 10 100 μs I_D - Drain Current (A) 10 ms 100 ms T_A = 25 °C Single Pulse 1 s 0.1 10 s DC **BVDSS** Limited 0.01 0.1 10 100 V_{DS} - Drain-to-Source Voltage (V) * V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified Safe Operating Area, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Ambient



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Case

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